



# **Specification**

#### COM27H2P90ULC

2,7" - 320 x 240 - CPU - Blanview

Spec Revision: 2.0

Revision Date: 28.07.2023

Note: This specification is subject to change without prior notice

# **Specifications for**

# **Blanview TFT-LCD Monitor**

( 2.7" QVGA 240 x RGB x 320 Portrait)

Version 2.0

(Please be sure to check the specifications latest version.)

#### MODEL COM27H2P90ULC

Customer's Approval	
Signature :	
Name :	
Section :	
Title:	
Date :	
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TOPPAN INC.

Issue:Jul.28,2023

### Version History

Ver.	Date	Page		Description			
0.0	Oct.4,2022	-	- Tentative issue				
1.0	May.24,2023	-	-	First issue			
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			Change	Page №			
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#### 1. Application

This Specification is applicable to 68.4 mm (2.7 inch) Blanview TFT-LCD monitor for non-military use.

- TOPPAN makes no warranty or assume no liability that use of this Product and/or any information including drawings in this Specification by Purchaser is not infringing any patent or other intellectual property rights owned by third parties, and TOPPAN shall not grant to Purchaser any right to use any patent or other intellectual property rights owned by third parties. Since this Specification contains TOPPAN's confidential information and copy right, Purchaser shall use them with high degree of care to prevent any unauthorized use, disclosure, duplication, publication or dissemination of TOPPAN's confidential information and copy right.
- If Purchaser intends to use this Products for an application which requires higher level of reliability
   and/or safety in functionality and/or accuracy such as transport equipment (aircraft, train, automobile, etc.),
   disaster-prevention/security equipment or various safety equipment,
   Purchaser shall consult TOPPAN on such use in advance.
- This Product shall not be used for application which requires extremely higher level of reliability and/or safety such as aerospace equipment, telecommunication equipment for trunk lines, control equipment for nuclear facilities or life-support medical equipment.
- It must be noted as an mechanical design manner, especial attention in housing design to prevent arcuation/flexure caused by stress to the LCD module shall be considered.
- TOPPAN assumes no liability for any damage resulting from misuse, abuse, and/or miss-operation of the Product deviating from the operating conditions and precautions described in the Specification.
- It shall be mutually conferred if nonconforming defect which result from unspecified cause in this specification arises.
- If any issue arises as to information provided in this Specification or any other information, TOPPAN and Purchaser shall discuss them in good faith and seek solution.
- TOPPAN assumes no liability for defects such as electrostatic discharge failure occurred during peeling off the protective film or Purchaser's assembly process.

⊚ This Product is compatible for RoHS(2.0) directive.

Object substance	Maximum content [ppm]
Cadmium and its compound	100
Hexavalent Chromium Compound	1000
Lead & Lead compound	1000
Mercury & Mercury compound	1000
Polybrominated biphenyl series (PBB series)	1000
Polybrominated biphenyl ether series (PBDE series)	1000
Bis(2-ethylhexyl)phthalate series(DEHP series)	1000
Butyl benzyl phthalate series(BBP series)	1000
Dibutyl phthalate series(DBP series)	1000
Diisobutyl phthalate series(DIBP series)	1000

#### 2. Outline Specifications

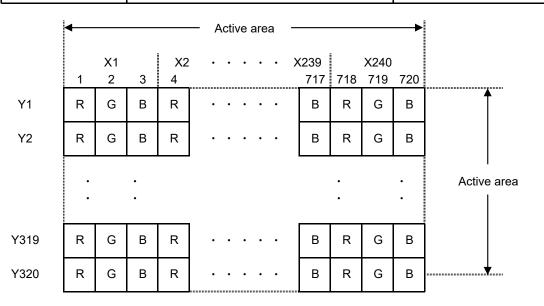
#### 2.1 Features of the Product

- 2.7 inch diagonal display, 720 [H] x 320 [V] dots. 240RGB x 320 pixel.
- 6-bit / 262,144 colors.
- Single power supply operation of 2.7V.
- Timing generator [TG], Counter-electrode driving circuitry, Built-in power supply circuit.
- Long life & High bright white LED back-light.
- Blanview TFT-LCD, improved outdoor visibility.

	Inde	oor	Outdoor			
	Visibility	Power Efficiency (Battery Life)	Visibility	Power Efficiency (Battery Life)		
Transmissive	Good	Good	Fair	Poor		
Transflective	Fair	Poor	Good	Good		
Blanview	Good	Good	Good	Good		

#### 2.2 Display Method

Items	Specifications	Remarks
Display type	VA type 262,144 colors	
	New-Blanview, Normally Black	
Driving method	a-Si TFT Active matrix	
	Line-scanning, Non-interlace	
Dot arrangement	RGB stripe arrangement	Refer to "Dot arrangement"
Signal input method	6-bit : CPU interface	
Backlight type	Long life & High bright white LED	
NTSC ratio	50%	

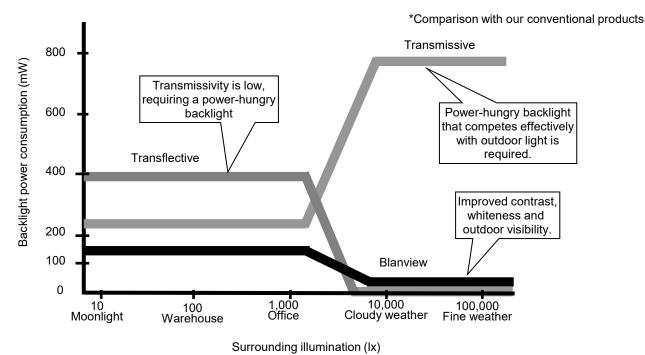


Dot arrangement (FPC cable placed left side)

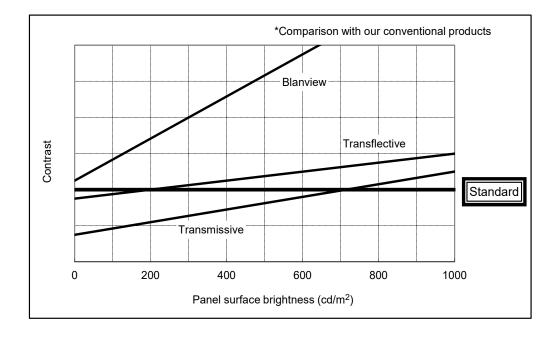
#### <Features of Blanview>

(TOPPAN criteria)

- Backlight power consumption required to assure visibility. (equivalent to 3.5"QVGA)



Contrast characteristics under 100,000lx. (same condition as direct sunlight.)
 With better contrast (higher contrast ratio), Blanview TFT-LCD has the best outdoor readability in three different types of TFT-LCD.
 Below chart shows contrast value against panel surface brightness. (Horizontal: Panel surface brightness/ Vertical: Contrast value) LCD panel has enough outdoor readability above our Standard line.

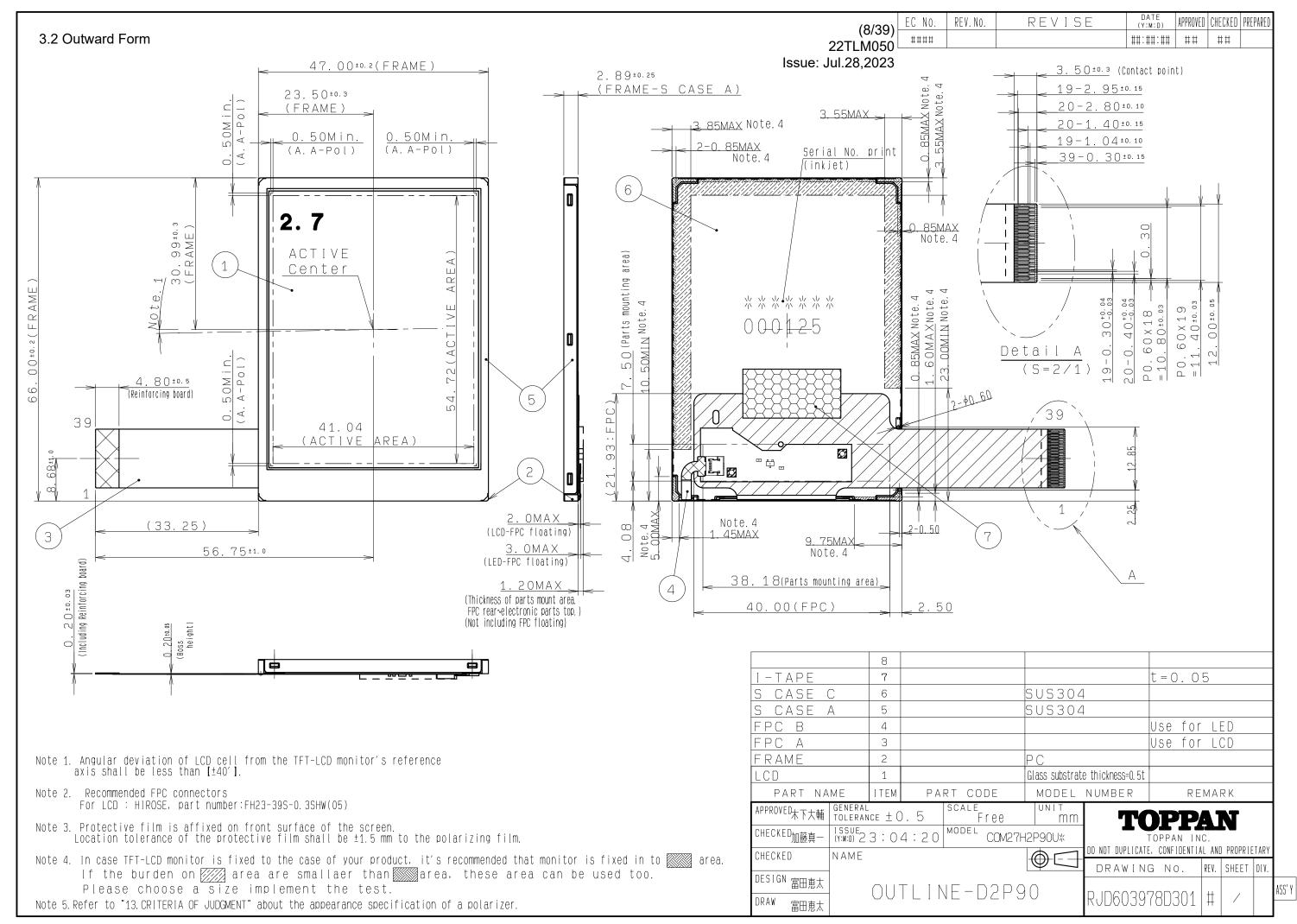


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#### 3. Dimensions and Shape

#### 3.1 Dimensions

Items	Specifications	Unit	Remarks
Outline dimensions	47.00[H] × 66.00[V] × 2.89[D]	mm	exclude FPC and components on the FPC
Active area	41.04[H] × 54.72[V]	mm	68.4mm diagonal
Number of dots	720[H] × 320[V]	dot	
Dot pitch	57.0[H] × 171.0[V]	um	
Surface hardness of	2	Н	
the polarizer			
Weight	19.0	g	Include FPC cable



#### 3.3 Serial № print (S-print)

#### 3.3.1 Display Items

S-print indicates the least significant digit of manufacture year (1digit), manufacture month with below alphabet (1letter), model code (5characters), serial number (6digits).

\* Contents of Display

* *		****	*****
_	_		
а	b	С	d

	Contents of display							
а	The least significant d	igit of manufacture year						
b	Manufacture month	Jan-A	May-E	Sep-I				
		Feb-B	Jun-F	Oct-J				
		Mar-C Jul-G Nov-K						
	Apr-D Aug-H Dec-L							
С	Model code 27HBC (Made in Japan)							
		27HCC (Made in Malaysia)						
d	Serial number							

<sup>\*</sup> Example of indication of Serial № print (S-print)

2L27HBC000125

means "manufactured in December 2022, 2.7" HB type, C specifications, serial number 000125"

· Made in Malaysia

2L27HCC000125

means "manufactured in December 2022, 2.7" HC type, C specifications, serial number 000125"

3.3.2 Location of Serial № print (S-print)

Refer to 3.2 "Outward Form".

#### 3.3.3 Others

Please note that it is likely to disappear with an organic solvent about the Serial print.

<sup>·</sup>Made in Japan

#### 4. Pin Assignment

No.	Symbol	Function						
1	VSS	GND						
2	VSS	GND						
3	VCI	Power supply for main circuit						
4	IOVCC	Power supply for I/O circuit						
5	VSS	GND						
6	RESETB	Reset signal (Lo-active)						
7	CSB	Chip selection signal (Lo:Select, Hi:Unselect)						
8	RS	Register selection signal(Lo:command, Hi:parameter / Display data)						
9	WRB	Write signal						
10	VSS	GND						
11	D0	Data I/O						
12	D1	Data I/O						
13	D2	Data I/O						
14	D3	Data I/O						
15	D4	Data I/O						
16	D5	Data I/O						
17	D6	Data I/O						
18	D7	Data I/O						
19	D8	Data I/O						
20	D9	Data I/O						
21	D10	Data I/O						
22	D11	Data I/O						
23	D12	Data I/O						
24	D13	Data I/O						
25	D14	Data I/O						
26	D15	Data I/O						
27	D16	Data I/O						
28	D17	Data I/O						
29	VSS	GND						
30	BS0	Interface mode setting terminal						
31	BS1	Interface mode setting terminal						
32	RDB	Read signal						
33	NC	Open						
34	NC	Open						
35	NC	Open						
36	NC	Open						
37	TE	Synchronization signal output						
38	BLH	LED drive power source. (Anode side)						
39	BLL	LED drive power source. (Cathode side)						

#### Note:

- Recommended connector: Hirose FH23 series "FH23-39S-0.3SHW(05)"
- In the circuit design, the terminal array of connector for use with terminal sequence of the "3.2 Outward Form", please be sure to check.
  - If the array of the signal input to the product is different, it may cause a malfunction.
- FPC of the terminal has been decorated with gold-plated.
   Connector contact terminals is recommended the use of gold-plated products.
- Interface mode setting terminals are fixed as follows on the FPC.
   BS2=GND

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#### 5. Absolute Maximum Rating

VSS=0V

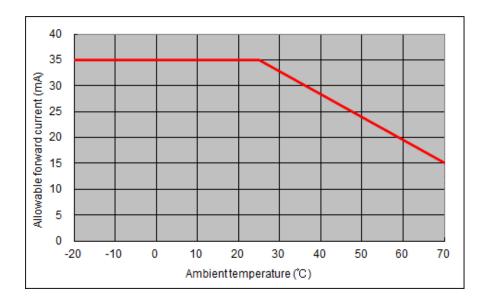
Item	Symbol	Condition	Rating		Unit	Applicable terminal
			MIN	MAX		
Supply voltage	VCI		-0.3	4.6	V	VCI
Supply voltage	IOVCC		-0.3	VCI	V	IOVCC
Input voltage for logic	VI		-0.3	IOVCC+0.3	V	RESETB,CSB,RS,WRB,D0-D17,
						BS0,BS1,RDB
LED Forward current	IL	Ta=25°C		35.0	mA	BLH - BLL
		Ta=70°C		15.0		
Storage temperature	Tstg		-30	80	°C	
range						
Storage atmospheric	Hstg	40°C90%RH c	RH or less of moisture content			
range		with no conde	nsation			

#### 6. Recommended Operating Conditions

VSS=0V

Item	Symbol	Condition		Rating		Unit	Applicable terminal
			MIN	TYP	MAX		
Supply voltage	VCI		2.6	2.7	3.6	V	VCI
Supply voltage	IOVCC		1.65	VCI	VCI	V	IOVCC
Input voltage for logic	VI		0	_	IOVCC	V	RESETB,CSB,RS,WRB, D0-D17,BS0,BS1,RDB
Operational temperature range	Тор	*note	-20	25	70	°C	LCD Panel surface temperature
Operating humidity	Нор	Ta≦40°C	20	=	85	%	
range		Ta> 40°C	40°C85%RH or less of moisture content with no condensation				

note: The maximum value of LED Forward current "IL", do not exceed the following allowable current value.



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#### 7. Electrical Characteristics

#### 7.1 DC Characteristics

#### 7.1.1 Display section

(Unless otherwise noted, Ta=25°C,VCI=2.7V,IOVCC=2.7V,VSS=0V)

Item	Symbol	Condition	Rating			Unit	Applicable terminal
			MIN	TYP	MAX		
Input Signal	VIH		0.7×IOVCC	_	IOVCC	V	RESETB,CSB,RS,WRB,
Voltage	VIL		0		0.3×IOVCC	V	D0-D17,BS0,BS1,RDB
Output Signal	VOH	IOH = -0.1mA	0.8×IOVCC		_	V	D0-D17,TE
Voltage	VOL	IOL = 0.1mA	_	_	0.2×IOVCC	V	
Operating	ICI	BS0=0	_	6.1	12.2	mA	VCI
Current	IOICC	Color bar *note	_	2	10	μA	IOVCC
		BS0=1	_	30	60	μA	
Standby	ICI	BS=0	_	6	30	uA	VCI
Current	IOICC	Other input with constant voltage	_	2	10	uA	IOVCC
		BS0=1	_	30	60	uA	

note: CPU is not accessing the display RAM, still image display state (Color bar display)

#### 7.1.2 Backlight section

Item	Symbol	Condition	Rating			Unit	Applicable terminal
			MIN	TYP	MAX		
Forward	IL25	Ta=25°C	_	7.0	35.0	mA	BLH - BLL
current	IL70	Ta=70°C	_	_	15.0	mA	
Forward voltage	VL	Ta=25°C, IL=7.0mA	_	8.0	8.5	V	
Estimated Life of LED	LL	Ta=25°C, IL=7.0mA *note	_	50,000	_	hrs	

#### note:

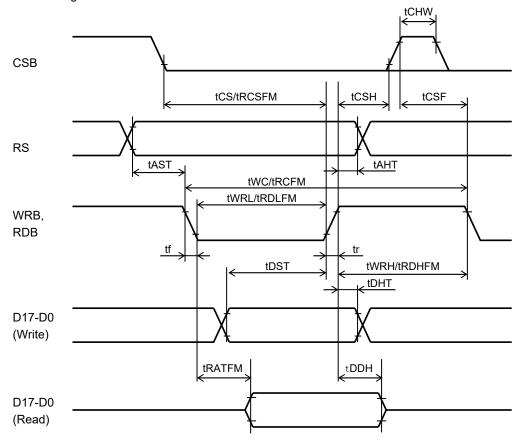
- The lifetime of the LED is defined as a period till the brightness of the LED decreases to the half of its initial value.
- This figure is given as a reference purpose only, and not as a guarantee.
- This figure is estimated for an LED operating alone.
  As the performance of an LED may differ when assembled as a monitor.
- Estimated lifetime could vary on a different temperature and usually higher temperature could reduce the life significantly.

#### 7.2 AC Characteristics

(Unless otherwise noted, Ta=25°C,VCI=2.7V,IOVCC=2.7V,VSS=0V)

Item	Symbol	Condition	Ra	ting	Unit
			MIN	MAX	
Address setup time	tAST	RS	0	-	ns
Address hold time	tAHT	RS	10	-	ns
CSB "High" level pulse width	tCHW	CSB	0	-	ns
CSB setup time	tCS	CSB-WRB	15	-	ns
	tRCSFM	CSB-RDB	355	-	ns
CSB wait time	tCSF	CSB	10	-	ns
CSB hold time	tCSH	CSB	10	-	ns
WRB bus cycle time	tWC	WRB	66	-	ns
WRB "High" level pulse width	tWRH	WRB	15	-	ns
WRB "Low" level pulse width	tWRL	WRB	15	-	ns
RDB bus cycle time	tRCFM	RDB	450	-	ns
RDB "High" level pulse width	tRDHFM	RDB	90	-	ns
RDB "Low" level pulse width	tRDLFM	RDB	355	-	ns
WRB data setup time	tDST	D17-D0	10	-	ns
WRB data hold time	tDHT	D17-D0	10	-	ns
RDB data delay time	tRATFM	D17-D0	-	340	ns
RDB output disable time	tDDH	D17-D0	20	80	ns
Input signal rise time	tr		-	15	ns
Input signal fall time	tf		-	15	ns

All timing is defined as the reference to the 30-70% of IOVCC.



#### 8. Interface

#### 8.1 Interface

Data width

/Parameter writing Transfer method

Command

1 pixel data BS1 BS0

R3Ah (Pixel Format) RB0h (RAM control Para2)

Display RAM writing						
	CPU					
18bit	16bit	8bit				
18	16	6+6+6				
18	16	18				
Н	L	Н				
L	L	Н				
06h	05h	06h				
E0h	E0h	E1h				

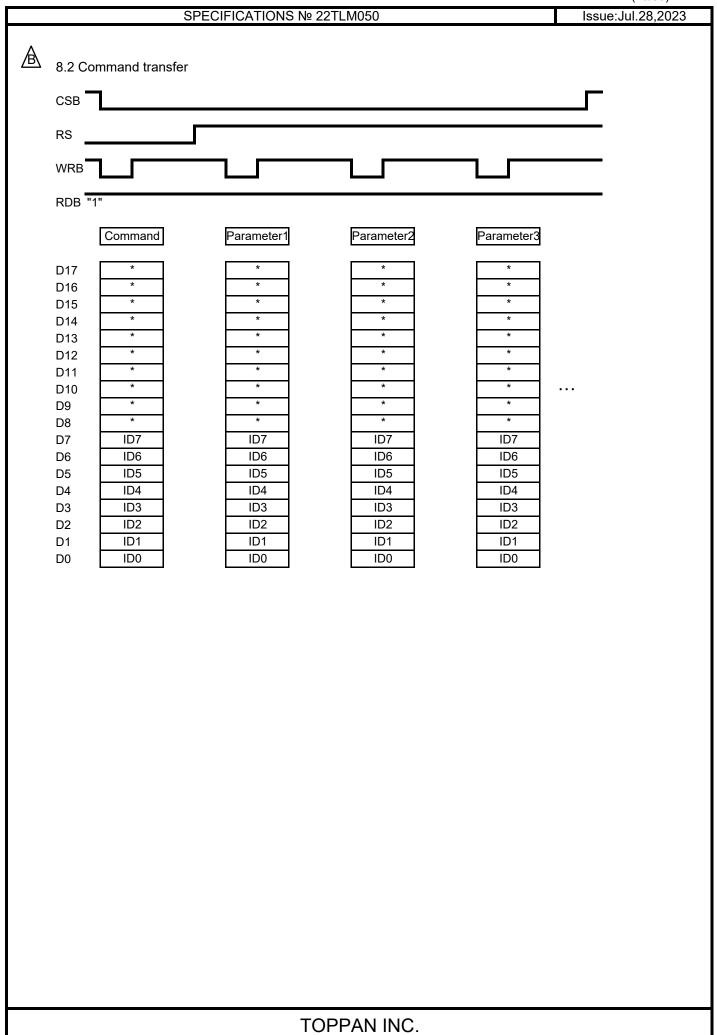
D17	
D16	
D15	
D14	
D13	
D12	
D11	
D10	
D9	
D8	
D7	
D6	
D5	
D4	
D3	
D2	
D1	
D0	

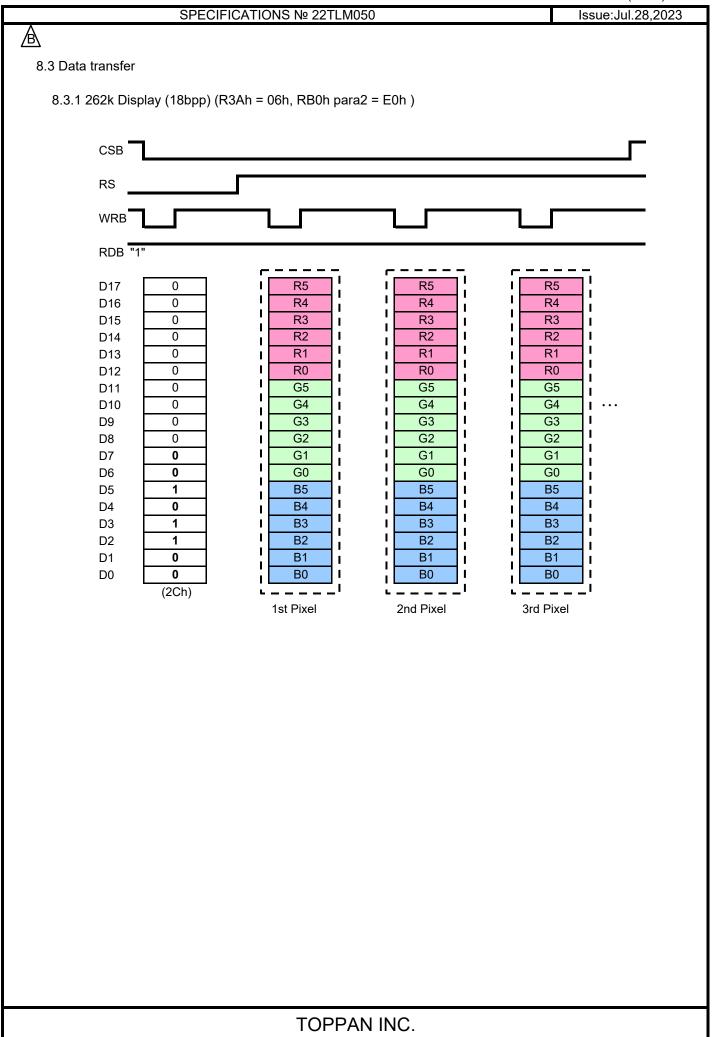
*	
*	
*	
*	
*	
*	
*	
*	
*	
*	
ID7	
ID6	
ID5	
ID4	
ID3	
ID2	
ID1	
ID0	

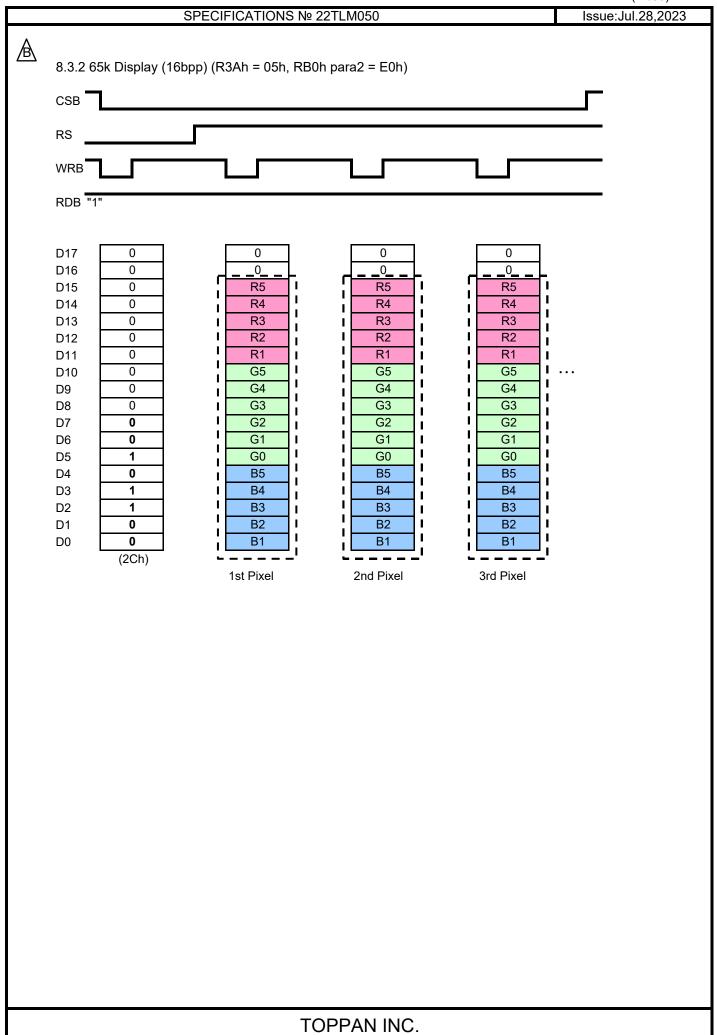
R5				
R4				
R3	R5			
R2	R4			
R1	R3			
R0	R2			
G5	R1			
G4	G5			
G3	G4			
G2	G3			
G1	G2	R5	G5	B5
G0	G1	R4	G4	В4
B5	G0	R3	G3	В3
B4	B5	R2	G2	B2
B3	В4	R1	G1	B1
B2	В3	R0	G0	В0
B1	B2			
В0	B1			

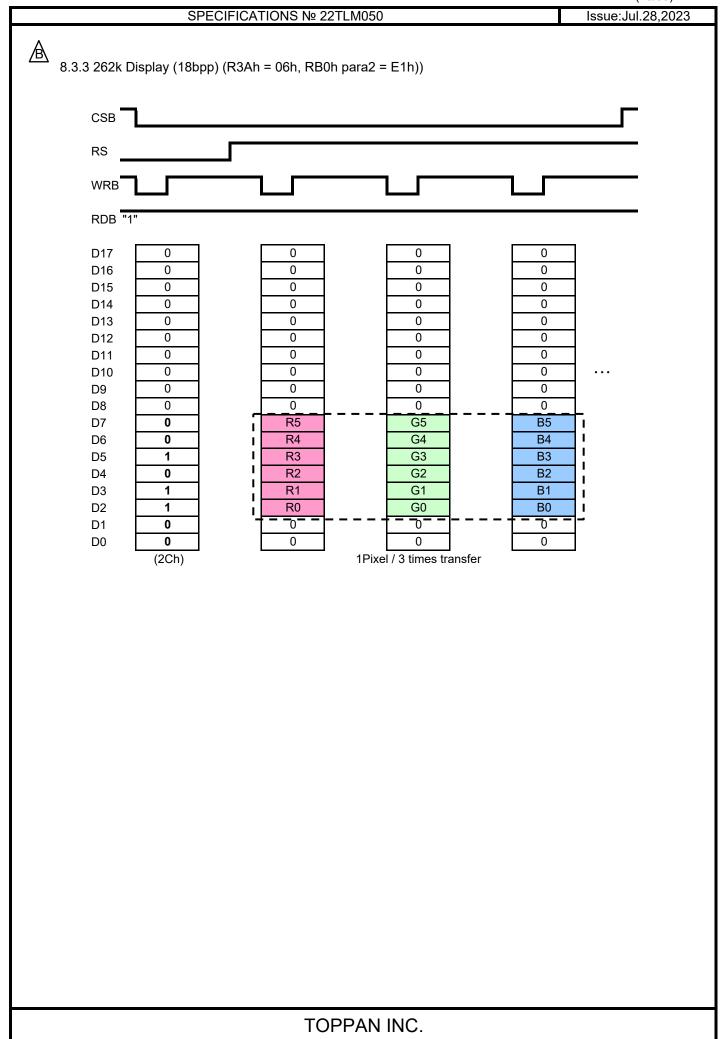
note - When swiching the interface, it is necessary to change the BS PIN and register settings.

- Unused terminal "D0~D17" should be connected to VSS.









# SPECIFICATIONS № 22TLM050

#### 9. Sequence

9.1 Power ON Sequence

(1/2)

					( 1/2
No.			RS	ID[7:0]	Remarks
	VCI/IOVCC ON				
	RESETB High RESETB Lov	,,			RESETB High can be omitted
	RESETB High → Low	v			
	Wait 10 usec or more				
	RESETB Low → High				
	Wait 120 msec or more				
1	Sleep Out		0	11 h	
	Wait 120 msec or more				
2	Memory access control		0	36 h	
		ara 1	1	00 h	MX=MY=0
3	LCM Control		0	C0 h	
		ara 1	1	3C h	XINV=XMV=XMX=XBGR=1
4	Pixel format		0	3A h	-
•		ara 1	1	05 h	05h:65k,06h:262k
5	CMD2EN		0	DF h	
Ū		ara 1	1	5A h	
		ara 2	1	69 h	
		ara 3	1	02 h	
	-	-	1	02 II	Command2 enable
-	GATECTRL 1	ara 4		E4 h	Command2 enable
6		1	0		NII 200
	<u> </u>	ara 1	1	27 h	NL=320
	·	ara 2	1	00 h	SCN=G0
		ara 3	1	10 h	TMG=1,SM=GS=0
7	GATECTRL 2		0	B7 h	
		ara 1	1	75 h	VGH=14.9,VGL=-10.4
8	VCOMS setting		0	BB h	
		ara 1	1	20 h	Δv=0.9typ
9	VAP/VAN signal		0	D2 h	
	<u>-</u>	ara 1	1	4C h	
10	VRH set		0	C3 h	
	р	ara 1	1	17 h	VAP=4.7+
11	Frame rate		0	C6 h	
	р	ara 1	1	EF h	Column inversion,60Hz
12	Power control 1		0	D0 h	
	р	ara 1	1	A4 h	
		ara 2	1	A1 h	
13	Positive gamma		0	E0 h	
		ara 1	1	F0 h	
	-	ara 2	1	04 h	
		ara 3	1	0B h	
		ara 4	1	11 h	
		ara 5	1	10 h	
		ara 6	1	1B h	
		ara 7	1	2F h	+
		ara 8	1	33 h	+
		ara 9	1	40 h	
		ra 10	1	27 h	
		ra 11	1	17 h	
		ra 12	1	14 h	
		ra 13	1	19 h	
		ra 14	1	23 h	

(2/2)

			-	( 2/2 )
No.		RS	ID[7:0]	Remarks
14	Negative gamma	0	E1 h	
	para 1	1	F0 h	
L	para 2	1	04 h	
	para 3	1	0B h	
	para 4	1	11 h	
	para 5	1	10 h	
	para 6	1	1B h	
	para 7	1	2F h	
	para 8	1	33 h	
	para 9	1	40 h	
	para 10	1	27 h	
	para 11	1	17 h	
	para 12	1	14 h	
	para 13	1	19 h	
	para 14	1	23 h	
Ī	Wait 10 msec or more			
15	Equalize control	0	E9 h	
ļ	para 1	1	08 h	
	para 2	1	08 h	
	para 3	1	00 h	
16	RGB interface control	0	B1 h	
	para 1	1	00 h	
	para 2	1	04 h	
	para 3	1	14 h	
17	RAM Control	0	B0 h	
Ī	para 1	1	00 h	RM=0,DM=00:CPU interface
ŀ	para 2	1	E0h / E1 h	When Data with 8bit, set "E1h".
18	CA SET	0	2A h	,
- 1	para 1	1	00 h	XS[15:8]
-	para 2	1	00 h	XS[7:0]
ŀ	para 3	1	00 h	XE[15:8]
F	para 4	1	EF h	XE[7:0]
19	RA SET	0	2B h	[]
	para 1	1	00 h	YS[15:8]
ŀ	para 2	1	00 h	YS[7:0]
ŀ	para 3	1	01 h	YE[15:8]
-	para 4	1	3F h	YE[7:0]
20	GT ADJ	0	B8 h	1 =[0]
	para 1	1	2A h	
F	para 2	<u>·</u> 1	2B h	
ŀ	para 3	1	14 h	
ŀ	para 4	1	F5 h	
21	Tearing Effect On	0	35 h	
- '	para 1	1	00 h	TEM = 0
22	RAMWR	0	2C h	I LIVI - U
	data 1	1	**** h	write data
	data 2	1 1	**** h	
ŀ	uata z	•••	• • • • h	write data
ŀ		1	**** h	write data
-	data n	I	n	write data
22	wait 10 msec or more		00 F	+
23	Display ON	0	29 h	<u> </u>
	wait 10 msec or more		ļ	_
24	Backlight ON		<u> </u>	

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#### 9.2 Sleep IN Sequence

No.		RS	ID[7:0]	Remarks
1	Backlight OFF			
2	Display OFF	0	28 h	
	Wait 10 msec or more			
3	Sleep In	0	10 h	

# 9.3 Sleep OUT Sequence

No.		RS	ID[7:0]	Remarks
1	Sleep Out	0	11 h	
	Wait 120 msec or more			
2	Display ON	0	29 h	
	Wait 50 msec or more			
3	Backlight ON			

#### 9.4 Power OFF Sequence

No.		RS	ID[7:0]	Remarks
1	Backlight OFF			
2	Display OFF	0	28 h	
	Wait 10 msec or more			
3	Sleep In	0	10 h	
	Wait 120 msec or more			
4	RESETB High $\rightarrow$ Low			
5	VCI/IOVCC OFF			

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#### 9.5 Refresh Sequence

(1/2)

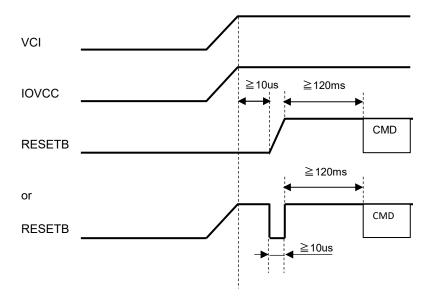
				( 1/2 )
No.		RS	ID[7:0]	Remarks
1	Sleep Out	0	11 h	
	Wait 120 msec or more			
2	Memory access control	0	36 h	
	para 1	1	00 h	MX=MY=0
3	LCM Control	0	C0 h	
	para 1	1	3C h	XINV=XMV=XMX=XBGR=1
4	Pixel format	0	3A h	
	para 1	1	05 h	05h:65k,06h:262k
5	CMD2EN	0	DF h	
	para 1	1	5A h	
	para 2	1	69 h	
	para 3	1	02 h	
	para 4	1	01 h	Command2 enable
6	GATECTRL 1	0	E4 h	
	para 1	1	27 h	NL=320
	para 2	1	00 h	SCN=G0
	para 3	1	10 h	TMG=1,SM=GS=0
7	GATECTRL 2	0	B7 h	
	para 1	1	75 h	VGH=14.9,VGL=-10.4
8	VCOMS setting	0	BB h	
	para 1	1	20 h	Δv=0.9typ
9	VAP/VAN signal	0	D2 h	1 27
	para 1	1	4C h	
10	VRH set	0	C3 h	
"	para 1	1	17 h	VAP=4.7+
11	Frame rate	0	C6 h	77.11
	para 1	1	EF h	Column inversion,60Hz
12	Power control 1	0	D0 h	
' <b>-</b>	para 1	1	A4 h	
	para 2	1	A1 h	
13	Positive gamma	0	E0 h	
10	para 1	1	F0 h	
	para 2	1	04 h	
	para 3	1	04 H	
	para 4	1	11 h	
-	para 5	1	10 h	
	para 6	1	1B h	
	· · · · · · · · · · · · · · · · · · ·			
	para 7	1	2F h	+
	para 8	1	33 h	+
	para 9	1	40 h	
	para 10	1	27 h	
	para 11	1	17 h	
	para 12	1	14 h	
	para 13	1	19 h	
	para 14	1	23 h	
	Wait 10 msec or more			

		ī		( 2/2 )
No.		RS	ID[7:0]	Remarks
14	Negative gamma	0	E1 h	
	para 1	1	F0 h	
	para 2	1	04 h	
	para 3	1	0B h	
	para 4	1	11 h	
	para 5	1	10 h	
	para 6	1	1B h	
	para 7	1	2F h	
	para 8	1	33 h	
	para 9	1	40 h	
	para 10	1	27 h	
	para 11	1	17 h	
	para 12	1	14 h	
	para 13		19 h	
	para 14	1	23 h	
	Wait 10 msec or more		=	
15	Equalize control	0	E9 h	
	para 1	1	08 h	
	para 2	1	08 h	
	para 3	1	00 h	
16	RGB interface control	0	B1 h	
	para 1	1	00 h	
	para 2	1	04 h	
	para 3	1	14 h	
17	RAM Control	0	B0 h	
	para 1	1	00 h	RM=0,DM=00:CPU interface
	para 2	1	E0h / E1 h	When Data with 8bit, set "E1h".
18	CA SET	0	2A h	
	para 1	1	00 h	XS[15:8]
	para 2	1	00 h	XS[7:0]
	para 3	1	00 h	XE[15:8]
	para 4	1	EF h	XE[7:0]
19	RA SET	0	2B h	
	para 1		00 h	YS[15:8]
	para 2	1	00 h	YS[7:0]
	para 3		01 h	YE[15:8]
	para 4	1	3F h	YE[7:0]
20	GT ADJ	0	B8 h	
	para 1	1	2A h	
	para 2	1	2B h	
	para 3		14 h	
	para 4	1	F5 h	
21	Tearing Effect On	0	35 h	
	para 1	1	00 h	TEM = 0
22	RAMWR	0	2C h	
	data 1	1	**** h	write data
	data 2	1	**** h	write data
	••••	•••	• • • • h	
	data n	1	**** h	write data
	wait 10 msec or more			
23	Display ON	0	29 h	
	wait 10 msec or more			

#### 9.6 Power ON/OFF timing

#### Power Supply ON Sequence

We recommend that you supplied at the same time VCI and IOVCC. However, there is no problem even if the supply IOVCC later than VCI. Please release the reset from at least 10us after each power supply.



#### Power Supply OFF Sequence

We recommend that you removed at the same time VCI and IOVCC. However, there is no problem even if IOVCC OFF faster than VCI .

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10. LED Circuit		
BLH O-		
BLL O-		
	TOPPAN INC.	

#### 11. Characteristics

#### 11.1 Optical Characteristics

(Measurement Condition)

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200 (OTSUKA ELECTRONICS), EZcontrastXL88 (ELDIM)

Driving condition: VCI=IOVCC=2.7V, VSS=0V, Optimized VCOMDC

Backlight: IL= 7.0 mA
Measured temperature: Ta = 25°C

	Item	Symbol	Condition	MIN	TYP	MAX	Unit	Note Nº	Remark
Response time	Rise time + Fall time	TON + TOFF	[Data]= 00h← → 3Fh	-	-	100	ms	1	
Contrast ratio	Backlight ON	CR	[Data]= 3Fh / 00h	400	800	-		2	
Cong	Backlight OFF			-	2.0	-			
<u></u>	Left	θL	[Data]=	80	-	-	deg	3	
Viewing angle	Right Up	θR	3Fh / 00h	80	-	-	deg		
je a⊓	Up	φU	CR ≧ 10	80	-	-	deg		
	Down	φD		80	-	-	deg		
White	e Chromaticity	Х	[Data]= 3Fh	White ch	romaticit	y range		4	
		У							
Cente	er Brightness		[Data]= 3Fh	240	350	-	cd/m²	5	
Brightness distribution			[Data]= 3Fh	70	-	-	%	6	
Burn-in				be obse	eable bui rved aftei pattern d	2 hours	_	7	

<sup>\*</sup> Note number 1 to 7: Refer to the APPENDIX of "Reference Method for Measuring Optical Characteristics and Performance".



White Chromaticity Range

(White Chromaticity Range)

Х	у
0.30	0.39
0.26	0.35
0.26	0.29
0.33	0.29
0.36	0.33
0.36	0.39

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#### 11.2 Temperature Characteristics

(Measurement Condition)

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200 (OTSUKA ELECTRONICS)

Driving condition: VCI=IOVCC=2.7V, VSS=0V, Optimized VCOMDC

Backlight: IL= 7.0 mA

Iter	Item		Specif	Remark	
			Ta = -20 °C	Ta = 70 °C	
Response time	Rise time + Fall time	TON + TOFF	1000 msec or less	80 msec or less	
Contrast ratio		CR	200 or more	200 or more	Backlight ON
Display Quality			No noticeable display d should be observed.	lefect or ununiformity	

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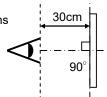
#### 12. Criteria of Judgment

#### 12.1 Defective Display and Screen Quality

Test Condition: Observed TFT-LCD monitor from front during operation with the following conditions

Driving Signal: Raster Patter (RGB, white, black) Signal condition: [Data]:00h, 28h, 3Fh (3steps)

Observation distance: 30 cm
Illuminance: 200 to 350 lx
Backlight: IL=7.0mA



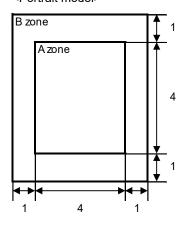
D	efect item	Defect content		Criteria
	Line defect	Black, white or co	olor line, 3 or more neighboring defective dots	Not exists
<u>i</u> £	Dot	Uneven brightne	ss on dot-by-dot base due to defective	Refer to table 1
Quality	defect	TFT or CF, or du	st is counted as dot defect	
		(brighter dot, dar	ker dot)	
Display		High bright dot: \	/isible through 2% ND filter at [Data]=00h	
Öis		Low bright dot: \	/isible through 5% ND filter at [Data]=00h	
		Dark dot: Appear	dark through white display at [Data]=28h	
		Invisible through	5% ND filter at [Data]=00h	Acceptable
	Stain	Uneven brightne	ss (white stain, black stain etc)	Invisible through 5% ND filter at Black screen. Invisible through 1% ND filter at other screen.
ĿŞ	Foreign	Point-like	0.25mm< φ	N=0
Quality	particle		0.20mm< φ ≦0.25mm	N≦2
			φ ≦0.20mm	Acceptable
Screen		Liner	3.0mm < length and 0.08mm < width	N=0
Sc			length $\leq$ 3.0mm or width $\leq$ 0.08mm	Acceptable
1	Others			Use boundary sample
				for judgment when necessary

 $\phi$ (mm): Average diameter = (major axis + minor axis)/2 Permissible number: N

#### Table1

Area	High bright dot	Low bright dot	Dark dot	Total	Criteria
Α	0	2	2	3	Permissible distance between same color bright dots
					(includes neighboring dots): 3 mm or more
В	2	4	4	5	Permissible distance between same color high bright dots
					(includes neighboring dots): 5 mm or more
Total	2	4	4	5	

#### <Portrait model>



Division of A and B areas

B area: Active area

Dimensional ratio between A and B areas: 1: 4: 1

(Refer to the left figure)

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#### 12.2 Screen and Other Appearance

Testing conditions

Observation distance: 30 cm

Illuminance: 1200  $\sim$  2000 lx

	Item	Criteria	Remark
	Flaw	Ignore invisible defect when the backlight is on.	Applicable area: Active area only
۳	Stain		(Refer to the section 3.2 Outward Form)
rize	Dirt		
olai	Dirt Bubble		
۵	Dust		
	Dent		
S	case	No functional defect occurs	
FF	PC .	No functional defect occurs	

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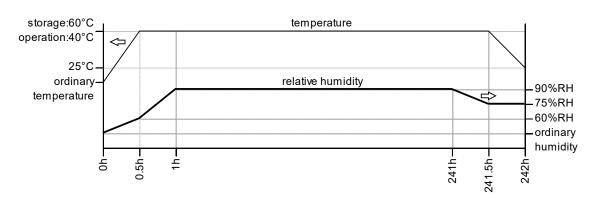
#### 13. Reliability Test

	Test item	Test cond	number of failures /	
				number of examinations
	High temperature storage	Ta = 80°C	240hrs	0/3
	Low temperature storage	Ta = -30°C	240hrs	0/3
	High temperature &	Ta = 60°C, RH = 90%,	240hrs	0/3
st	high humidity storage	non condensing	*	
Durability test	High temperature operation	Tp = 70°C	240hrs	0/3
i≝	Low temperature operation	Tp = -20°C	240hrs	0/3
ırat	High temperature &	Tp = 40°C, RH = 90%,	240hrs	0/3
ے ا	high humidity operation	non condensing	*	
	Thermal shock storage	-30°C ↔ 80°C (30min / 30min)	100cycles	0/3
	Lightfastness	Xenon Blackpanel 63±3°C non-sho	ower	0/3
		450W/㎡(300∼700nm) non-opera	ting Integral dose 800MJ/㎡	
	Electrostatic discharge test	Confirms to EIAJ ED-4701/300, C=	0/3	
est	(Non operation)	Each 3 times of discharge on and I		
<u>a</u>		and other terminals.		
ent	Surface discharge test	C=250pF, R=100Ω, V=±12kV	0/3	
Ě	(Non operation)	Each 5 times of discharge in both p		
į.		on the center of screen with the ca	se grounded.	
en	Vibration test	Total amplitude 1.5mm, f=10 $\sim$ 55 $\vdash$	0/3	
g		X,Y,Z directions for each 2 hours		
Mechanical environmental test	Impact test	Use TOPPAN original jig (see next	0/3	
Sch.		make an impact with peak accelera	ation of 1000m/s <sup>2</sup> for 6 msec	
₩		with half sine-curve at 3 times to ea	ach X, Y, Z directions	
		in conformance with JIS C 60068-2	2-27-2011.	
	Packing vibration-proof test	Acceleration of 19.6m/s <sup>2</sup> with frequ	ency of 10→55→10Hz,	0 / 1 packing
cking est		X,Y, Zdirection for each 30 minutes	S	
Packing test	Packing drop test	Drop from 75cm high.		0 / 1 packing
		1 time to each 6 surfaces, 3 edges	, 1 corner	

Note:Ta=ambient temperature Tp=Pa

Tp=Panel temperature

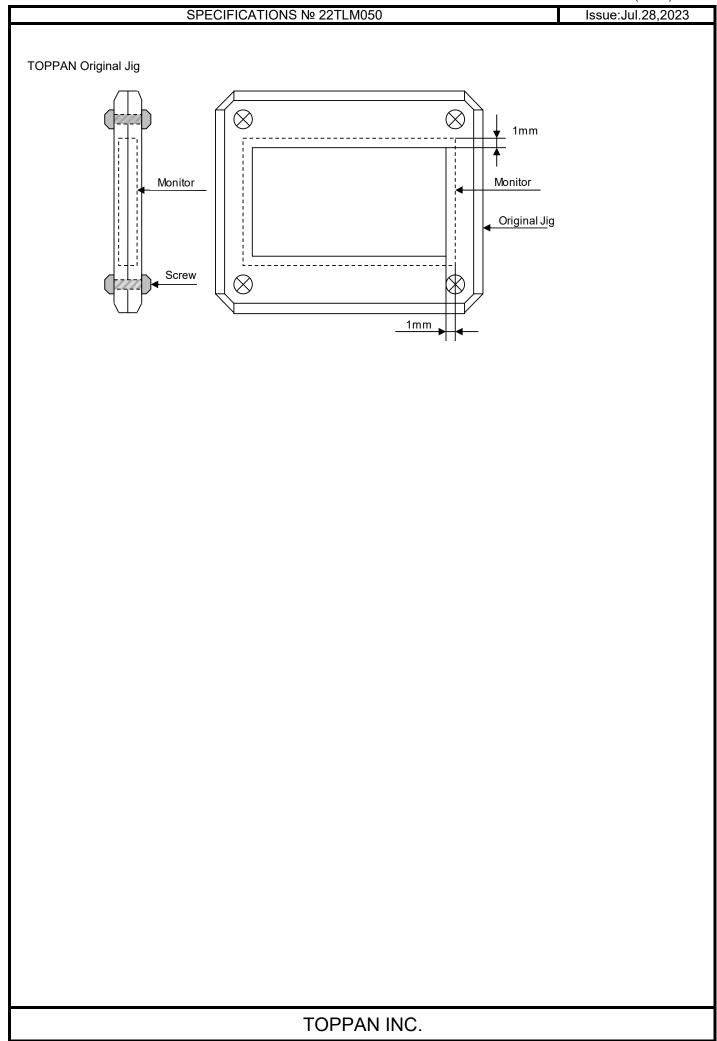
% The profile of high temperature/humidity storage and High Temperature/humidity operation (Pure water of over 10M $\Omega$ ·cm shall be used.)



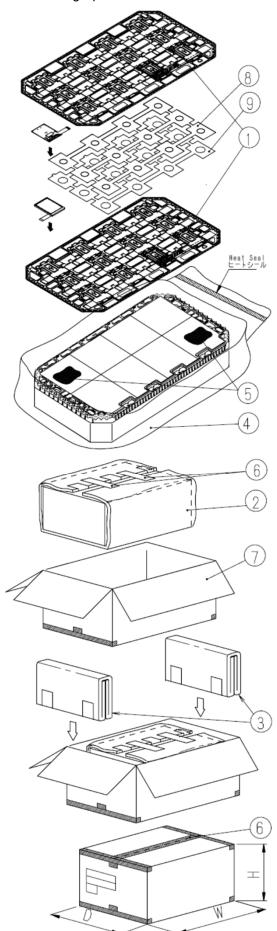
#### Table2. Reliability Criteria

The parameters should be measured after leaving the monitor at the ordinary temperature for 24 hours or more after the test completion.

Item	Standard	Remark
Display quality	No visible abnormality shall be seen.	
	(Except for unevenness by Pol deterioration.)	
Contrast ratio	200 or more	Backlight ON



#### 14. Packing Specifications



- Step 1. Each product is to be placed in one of the cut-outs of the tray with the display surface facing upward.

  Foam sheet A/B are to be placed on the products in the tray.

  Each product is to be placed in one of the cut-outs of the tray with the display surface facing downward.(24products per tray)
- Step 2. Each tray is to be piled up in same orientation and the trays be in a stack of 6.

  One empty tray is to be put on the top of stack of 6 trays.
- Step 3. 2 packs of moisture absorbers are to be placed on the top tray as shown in the drawing.

  Put piled trays into a sealing bag.
- Step 4. Vacuum and seal the sealing bag with the vacuum sealing machine.
- Step 5. The stack of trays in the plastic back is to be wrapped with B SHEET A.
- Step 6. The wrapped trays are placed in the carton.
- Step 7. B SHEET B are to be inserted into a outer carton with same orientation.

  The outer carton is to be sealed in H-shape with packing tape as shown in the drawing.
- Step 8. The model number, quantity of products, and shipping date are to be printed on the outer carton.If necessary, shipping labels or impression markings are to be put on the outer carton.

Remark: The return of packing materials is not required.

Packing item nar	me Specs., Material
① Tray	A-PET
② B SHEET A	Anti-static air bubble sheet
③ B SHEET B	Anti-static air bubble sheet
Sealing bag	
⑤ Drier	Moisture absorber
6 Packing tape	
⑦ Outer carton	Corrugated cardboard
8 FOAM SHEET A	A Anti-static polyethylene
9 FOAM SHEET I	B Anti-static polyethylene

Dimension of outer carton		
D : Approx.	( 337mm )	
W : Approx.	( 618mm )	
H : Approx.	( 179mm )	
Quantity of products packed in one carton:		144
Gross weight : Approx.		5.2 kg

#### 15. Handling Instruction

#### 15.1 Cautions for Handling LCD panels



#### Caution

- (1) Do not make an impact on the LCD panel glass because it may break and you may get injured from it.
- (2) If the glass breaks, do not touch it with bare hands.
  (Fragment of broken glass may stick you or you cut yourself on it.
- (3) If you get injured, receive adequate first aid and consult a medial doctor.
- (4) Do not let liquid crystal get into your mouth. (If the LCD panel glass breaks, try not let liquid crystal get into your mouth even toxic property of liquid crystal has not been confirmed.)
- (5) If liquid crystal adheres, rinse it out thoroughly.
  (If liquid crystal adheres to your cloth or skin, wipe it off with rubbing alcohol or wash it thoroughly with soap.
  If liquid crystal gets into eyes, rinse it with clean water for at least 15 minutes and consult an eye doctor.
- (6) If you scrap this products, follow a disposal standard of industrial waste that is legally valid in the community, country or territory where you reside.
- (7) Do not connect or disconnect this product while its application products is powered on.
- (8) Do not attempt to disassemble or modify this product as it is precision component.
- (9) If a part of soldering part has been exposed, and avoid contact (short-circuit) with a metallic part of the case etc. about FPC of this model, please. Please insulate it with the insulating tape etc. if necessary. The defective operation is caused, and there is a possibility to generation of heat and the ignition.
- (10) Since excess current protection circuit is not built in this TFT module, there is the possibility that LCD module or peripheral circuit become feverish and burned in case abnormal operation is generated. We recommend you to add excess current protection circuit to power supply.
- (11) The devices on the FPC are damageable to electrostatic discharge, because the terminals of the devices are exposed.
  Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors.
  Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.



#### Caution

This mark is used to indicate a precaution or an instruction which, if not correctly observed, may result in bodily injury, or material damages alone.

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#### 15.2 Precautions for Handling

- Wear finger tips at incoming inspection and for handling the TFT monitors to keep display quality and keep the working area clean.
   Do not touch the surface of the monitor as it is easily scratched.
- Wear grounded wrist-straps and use electrostatic neutralization blowers to prevent static charge and discharge when handling the TFT monitors as the LED in this TFT monitors is damageable to electrostatic discharge.
  Designate an appropriate operating area, and set equipment, tools, and machines properly when handling this product.
- 3) Avoid strong mechanical shock including knocking, hitting or dropping to the TFT monitors for protecting their glass parts. Do not use the TFT monitors that have been experienced dropping or strong mechanical shock.
- 4) Do not use or storage the TFT monitors at high temperature and high humidity environment.

  Particularly, never use or storage the TFT monitors at a location where condensation builds up.
- 5) Avoid using and storing TFT monitors at a location where they are exposed to direct sunlight or ultraviolet rays to prevent the LCD panels from deterioration by ultraviolet rays.
- Do not stain or damage the contacts of the FPC cable .
   FPC cable needs to be inserted until it can reach to the end of connector slot.
   During insertion, make sure to keep the cable in a horizontal position to avoid an oblique insertion.
   Otherwise, it may cause poor contact or deteriorate reliability of the FPC cable.
- 7) The FPC cable is a design very weak to the bend and the pull as it is fixed with the tape. Do not bend or pull the FPC cable or carry the TFT monitor by holding the FPC cable.
- Peel off the protective film on the TFT monitors during mounting process.
   Refer to the section 15.5 on how to peel off the protective film.
   We are not responsible for electrostatic discharge failures or other defects occur when peeling off the protective film.

#### 15.3 Precautions for Operation

- Since this TFT monitors are not equipped with light shielding for the driver IC, do not expose the driver IC to strong lights during operation as it may cause functional failures.
- In case of powering up or powering off this LCD module, be sure to comply the sequence as instructed in this specification.
- 3) Do not plug in or out the FPC cable while power supply is switch on. Plug the FPC cable in and out while power supply is switched off.
- 4) Do not operate the TFT monitors in the strong magnetic field. It may break the TFT monitors.
- 5) Do not display a fixed image on the screen for a long time. Use a screen-saver or other measures to avoid a fixed image displayed on the screen for a long time. Otherwise, it may cause burn-in image on the screen due the characteristics of liquid crystal.

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#### 15.4 Storage Condition for Shipping Cartons

(Storage environment)

Temperature 0 to 40°CHumidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or

wiring materials should be detected.

Time period 1 year

Unpacking To prevent damages caused by static electricity, anti-static precautionary measures

(e.g. earthing, anti-static mat) should be implemented.

After unpack, keep product in the appropriate condition,

otherwise bubble seal of Protective film may be printed on Polarizer.

Maximum piling up 8 cartons (excluding the bottom)

#### \*Conditions to storage after unpacking

#### (Storage environment)

Temperature 0 to 40°CHumidity 60%RH or less

No-condensing occurs under low temperature with high humidity condition.

Atmosphere No poisonous gas that can erode electronic components and/or

wiring materials should be detected.

Time period 1 year (Shelf life)

Others Keep/ store away from direct sunlight

Storage goods on original tray made by TOPPAN.

#### 15.5 Precautions for Peeling off the Protective film

The followings work environment and work method are recommended to prevent the TFT monitors from static damage or adhesion of dust when peeling off the protective films.

#### A) Work Environment

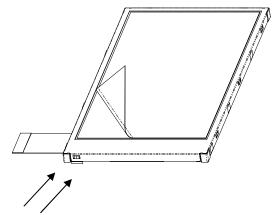
- a) Humidity: 50 to 70 %RH, Temperature15 to 27 °C
- b) Operators should wear conductive shoes, conductive clothes, conductive finger tips and grounded wrist-straps.

  Use an electrostatic neutralization blower.
- c) Anti-static treatment should be implemented to work area's floor.
   Use a room shielded against outside dust with sticky floor mat laid at the entrance to eliminate dirt.

#### B) Work Method

The following procedures should taken to prevent the driver ICs from charging and discharging.

- a) Use an electrostatic neutralization blower to blow air on the TFT monitors to its lower left when FPC is placed at the bottom.
   Optimize direction of the blowing air and the distance between the TFT monitors and the electrostatic neutralization blower.
- b) Put an adhesive tape (Scotch tape, etc) at the lower left corner area of the protective film to prevent scratch on surface of TFT monitors.
- c) Peel off the adhesive tape slowly (spending more than 2 secs to complete) by pulling it to opposite direction.



Blower wind direction (Set an ion blower with its adequate conditions.)

#### 15.6 Warranty

TOPPAN is only liable to defective goods which is stored and used under the condition complying with this specifications and returned within 1 (one) year.

Warranty caused by manufacturing defect shall be conducted by replacement of goods or refundment at unit price.

#### **APPENDIX**

Reference Method for Measuring Optical Characteristics and Performance

1. Measurement Condition (Backlight ON)

Measuring instruments: CS2000 (KONICA MINOLTA), LCD7200(OTSUKA ELECTRONICS), EZcontrastXL88 (ELDIM)

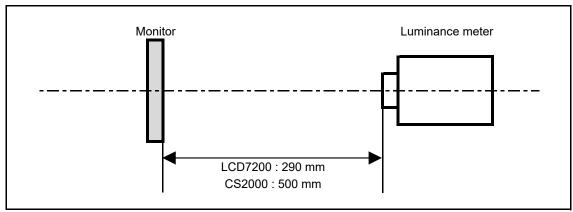
Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified

Measurement system: See the chart below. The luminance meter is placed on the normal line of measurement system.

Measurement point: At the center of the screen unless otherwise specified

Dark box at constant temperature

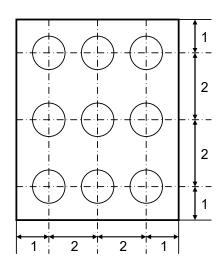


<sup>\*</sup>Measurement is made after 30 minutes of lighting of the backlight.

Measurement point: At the center point of the screen

Brightness distribution: 9 points shown in the following drawing.

<Portrait model>



Dimensional ratio of active area

Backlight IL=7.0mA

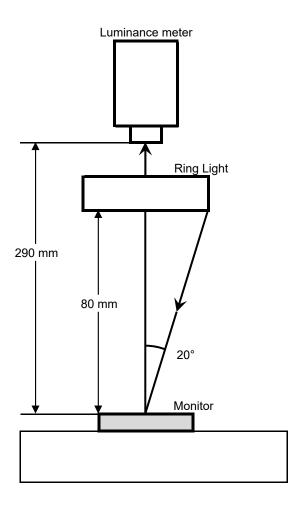
Measurement Condition (Contrast ratio Backlight OFF only)

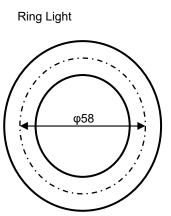
Measuring instruments: LCD7200(OTSUKA ELECTRONICS), Ring Light (40,000 lx,  $\phi$ 58)

Driving condition: Refer to the section "Optical Characteristics"

Measured temperature: 25°C unless specified Measurement system: See the chart below.

Measurement point: At the center of the screen unless otherwise specified





. Test	Method			
otice	Item	Test method	Measuring instrument	Remark
1	Response time	Measure output signal waveform by the luminance meter when raster of window pattern is changed from white to black and from black to white.  Black  100%  90%  TOFF	LCD7200	Black display [Data]=00h White display [Data]=3Fh TON Rise time TOFF Fall time
2	Contrast ratio	Measure maximum luminance Y1([Data]=3Fh) and minimum luminance Y2([Data]=00h) at the center of the screen by displaying raster or window pattern.  Then calculate the ratio between these two values.  Contrast ratio = Y1/Y2  Diameter of measuring point: 7.8mmφ(CS2000)  Diameter of measuring point: 3mmφ(LCD7200)	CS2000 LCD7200	Backlight ON Backlight OFF
3	Viewing angle Horizontalθ Verticalφ	Move the luminance meter from right to left and up and down and determine the angles where contrast ratio is 10.	EZcontrastXL88	
4	White chromaticity	Measure chromaticity coordinates x and y of CIE1931 colorimetric system at [Data] = 3Fh Color matching function: 2°view measurement angle: 1°	CS2000	
5	Center brightness	Measure the brightness at the center of the screen.	CS2000	
6	Brightness distribution	(Brightness distribution) = 100 x B/A % A: max. brightness of the 9 points B: min. brightness of the 9 points	CS2000	
7	Burn-in	Visually check burn-in image on the screen after 2 hours of "window display" ([Data]=00h/3Fh).		At optimized VCOMDC

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